LNP093014S

Panel Display Units

White Type

■ Structure

• Illumination color: White

Display surface: 192 mm × 96 mm
 Number of dots (dot): 1152 (48 × 24 dot)

• Dot size: 1.60 mm × 0.80 mm

• Dot pitch: 4.0 mm

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Operating supply voltage	V _{CC}	- 0.3 to +5.25	V	
LED operating supply voltage	V _{LEDA}	+5.2	V	
Input voltage	V _{IN}	-0.3 to $V_{CC} + 0.3$	V	
Operating ambient temperature	T _{opr}	-10 to +45	°C	
Storage temperature	T_{stg}	-25 to +80	°C	

■ Recommending Operating Conditions $T_a = 25$ °C±3°C

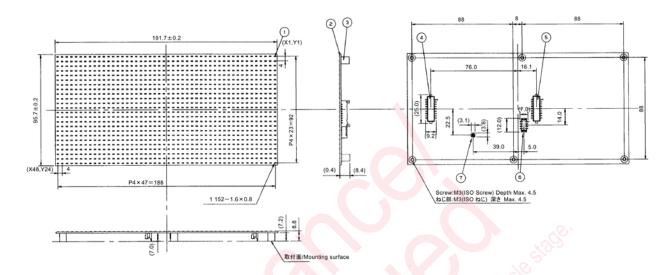
Parameter	Symbol	Min	Тур	Max	Unit
Operating supply voltage	V _{CC}	4.75	5.0	5.25	V
LED operating supply voltage	V _{LEDA}	4.80	5.0	5.20	V
Input voltage	V _{IN}	0.00	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	Vcc	V

■ Electro-Optical Characteristics $T_a = 25$ °C, $V_{CC} = V_{LEDA} = 5.0 \text{ V}$

Parameter	Symbol	1,80	Unit	
Brightness	, <u> </u>	White	Тур. 1600	cd/m ²
Dot brightness dispersion	_	≤ 2.5 times	_	
Modulated light	_	8 stage	_	
Viewing angle	$2\theta_{1/2}$	Horizontal direction	± 85	0
		Vertical direction	Upper side: 85, Under side: 85	0
Drive system	_	Duty 1/24 Dynamic l	_	
Clock frequency	f_{CLK}	Max. 10		MHz
Supply current (Logic) *	I _{CC(LOGIC)}	Max. 0.3		A
Supply current (LED) *	I _{CC(LED)}	Max. 3.5		A

Note) *: Full-color lighting

■ Package (Unit: mm)



- Part name
 - 1. LED
 - 2. Printed board
 - 3. Boss
 - 4. Signal connector (input)
 - 5. Signal connector (output)
 - 6. Supply connector
 - 7. Volume

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